

## IV2Q12040D7Z – 1200V 40mΩ Gen2 Automotive SiC MOSFET

### Features

- 2<sup>nd</sup> Generation SiC MOSFET Technology with +15V~+18V gate drive
- High blocking voltage with low on-resistance
- High speed switching with low capacitance
- 175°C operating junction temperature capability
- Ultra fast and robust intrinsic body diode
- Kelvin gate input easing driver circuit design
- AEC-Q101 qualified

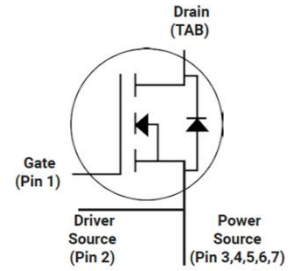
### Applications

- EV chargers and OBCs
- Solar boosters
- Automotive compressor inverters
- AC/DC power supplies

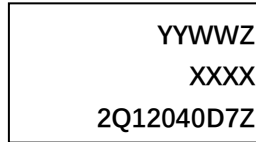
### Outline:



TO263-7



### Marking Diagram:



2Q12040D7Z = Specific Device Code  
 YY = Year  
 WW = Work Week  
 Z = Assembly Location  
 XXXX = Lot Traceability

### Absolute Maximum Ratings (T<sub>c</sub>=25°C unless otherwise specified)

Symbol	Parameter	Value	Unit	Test Conditions	Note
V <sub>DS</sub>	Drain-Source voltage	1200	V	V <sub>GS</sub> =0V, I <sub>D</sub> =100μA	
V <sub>GSmax</sub> (Transient)	Maximum transient voltage	-10 to 23	V	Duty cycle<1%, and pulse width<200ns	
V <sub>GSon</sub>	Recommended turn-on voltage	15 to 18	V		
V <sub>GSoff</sub>	Recommended turn-off voltage	-5 to -2	V	Typical -3.5V	
I <sub>D</sub>	Drain current (continuous)	65	A	V <sub>GS</sub> =18V, T <sub>c</sub> =25°C	Fig. 23
		48	A	V <sub>GS</sub> =18V, T <sub>c</sub> =100°C	
I <sub>DM</sub>	Drain current (pulsed)	162	A	Pulse width limited by SOA and dynamic R <sub>θ(j-c)</sub>	Fig. 25,26
I <sub>SM</sub>	Body diode current (pulsed)	162	A	Pulse width limited by SOA and dynamic R <sub>θ(j-c)</sub>	Fig. 25,26
P <sub>TOT</sub>	Total power dissipation	417	W	T <sub>c</sub> =25°C	Fig. 24
T <sub>stg</sub>	Storage temperature range	-55 to 175	°C		
T <sub>J</sub>	Operating junction temperature	-55 to 175	°C		
T <sub>L</sub>	Solder Temperature	260	°C	wave soldering only allowed at leads, 1.6mm from case for 10 s	

### Thermal Data

Symbol	Parameter	Value	Unit	Note
R <sub>θ(j-c)</sub>	Thermal Resistance from Junction to Case	0.36	°C/W	Fig. 25

**Electrical Characteristics** ( $T_c=25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter	Value			Unit	Test Conditions	Note
		Min.	Typ.	Max.			
$I_{DSS}$	Zero gate voltage drain current		5	100	$\mu\text{A}$	$V_{DS}=1200\text{V}, V_{GS}=0\text{V}$	
$I_{GSS}$	Gate leakage current			$\pm 100$	$\text{nA}$	$V_{DS}=0\text{V}, V_{GS}=-5\sim 20\text{V}$	
$V_{TH}$	Gate threshold voltage	1.8	2.8	4.5	$\text{V}$	$V_{GS}=V_{DS}, I_D=9\text{mA}$	Fig. 8, 9
			2.1			$V_{GS}=V_{DS}, I_D=9\text{mA}$ @ $T_J=175^\circ\text{C}$	
$R_{ON}$	Static drain-source on-resistance		40	52	$\text{m}\Omega$	$V_{GS}=18\text{V}, I_D=20\text{A}$ @ $T_J=25^\circ\text{C}$	Fig. 4, 5, 6, 7
			75		$\text{m}\Omega$	$V_{GS}=18\text{V}, I_D=20\text{A}$ @ $T_J=175^\circ\text{C}$	
$R_{ON}$			50	70	$\text{m}\Omega$	$V_{GS}=15\text{V}, I_D=20\text{A}$ @ $T_J=25^\circ\text{C}$	
			80		$\text{m}\Omega$	$V_{GS}=15\text{V}, I_D=20\text{A}$ @ $T_J=175^\circ\text{C}$	
$C_{iss}$	Input capacitance		2160		$\text{pF}$	$V_{DS}=800\text{V}, V_{GS}=0\text{V},$ $f=1\text{MHz}, V_{AC}=25\text{mV}$	Fig. 16
$C_{oss}$	Output capacitance		100		$\text{pF}$		
$C_{rss}$	Reverse transfer capacitance		5.8		$\text{pF}$		
$E_{oss}$	$C_{oss}$ stored energy		40		$\mu\text{J}$		Fig. 17
$Q_g$	Total gate charge		110		$\text{nC}$	$V_{DS}=800\text{V}, I_D=30\text{A},$ $V_{GS}=-3$ to $18\text{V}$	Fig. 18
$Q_{gs}$	Gate-source charge		25		$\text{nC}$		
$Q_{gd}$	Gate-drain charge		59		$\text{nC}$		
$R_g$	Gate input resistance		2.1		$\Omega$	$f=1\text{MHz}$	
$E_{ON}$	Turn-on switching energy		571.7		$\mu\text{J}$	$V_{DS}=800\text{V}, I_D=30\text{A},$ $V_{GS}=-3.5$ to $18\text{V},$ $R_{G(\text{ext})}=3.3\Omega,$ $L=200\mu\text{H}$ $T_J=25^\circ\text{C}$	Fig. 19, 20
$E_{OFF}$	Turn-off switching energy		62.2		$\mu\text{J}$		
$t_{d(\text{on})}$	Turn-on delay time		11.0		ns		
$t_r$	Rise time		19.6				
$t_{d(\text{off})}$	Turn-off delay time		20.8				
$t_f$	Fall time		11.6				
$E_{ON}$	Turn-on switching energy		872.1		$\mu\text{J}$	$V_{DS}=800\text{V}, I_D=30\text{A},$ $V_{GS}=-3.5$ to $18\text{V},$ $R_{G(\text{ext})}=3.3\Omega, L=200\mu\text{H}$ $T_J=175^\circ\text{C}$	Fig. 22
$E_{OFF}$	Turn-off switching energy		56.9		$\mu\text{J}$		

**Reverse Diode Characteristics** ( $T_c=25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter	Value			Unit	Test Conditions	Note
		Min.	Typ.	Max.			
$V_{SD}$	Diode forward voltage		4.1		V	$I_{SD}=20\text{A}, V_{GS}=0\text{V}$	Fig. 10, 11, 12
			4.0		V	$I_{SD}=20\text{A}, V_{GS}=0\text{V}, T_J=175^\circ\text{C}$	
$I_S$	Diode forward current (continuous)			63	A	$V_{GS}=-2\text{V}, T_c=25^\circ\text{C}$	
				36	A	$V_{GS}=-2\text{V}, T_c=100^\circ\text{C}$	
$t_{rr}$	Reverse recovery time		47		ns	$V_{GS}=-3.5\text{V}/+18\text{V}, I_{SD}=30\text{A}, V_R=800\text{V}, R_{G(\text{ext})}=13\Omega, L=200\mu\text{H}, di/dt=3000\text{A}/\mu\text{s}$	
$Q_{rr}$	Reverse recovery charge		203		nC		
$I_{RRM}$	Peak reverse recovery current		16.4		A		

**Typical Performance (curves)**

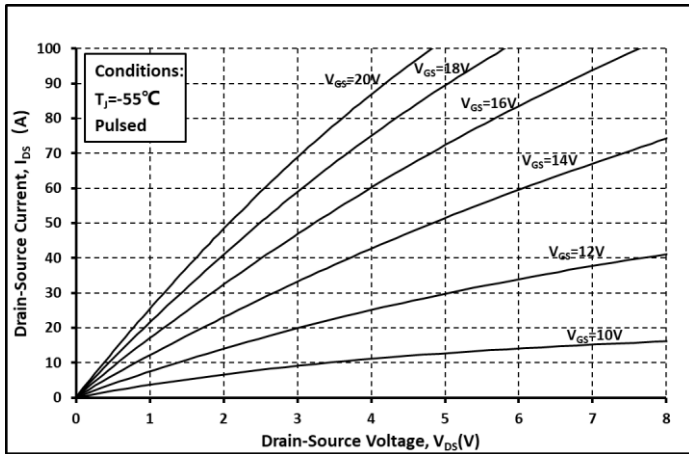


Fig. 1 Output Curve @  $T_J=-55^\circ\text{C}$

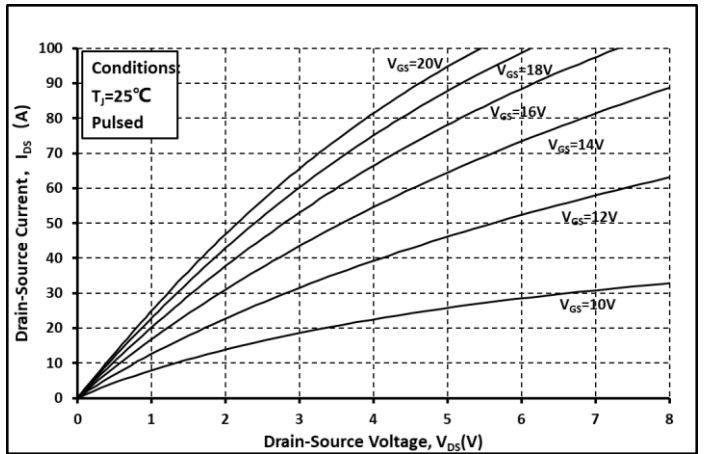


Fig. 2 Output Curve @  $T_J=25^\circ\text{C}$

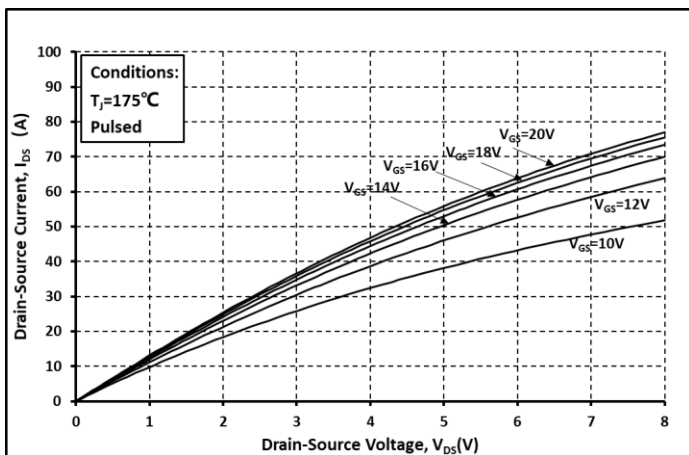


Fig. 3 Output Curve @  $T_J=175^\circ\text{C}$

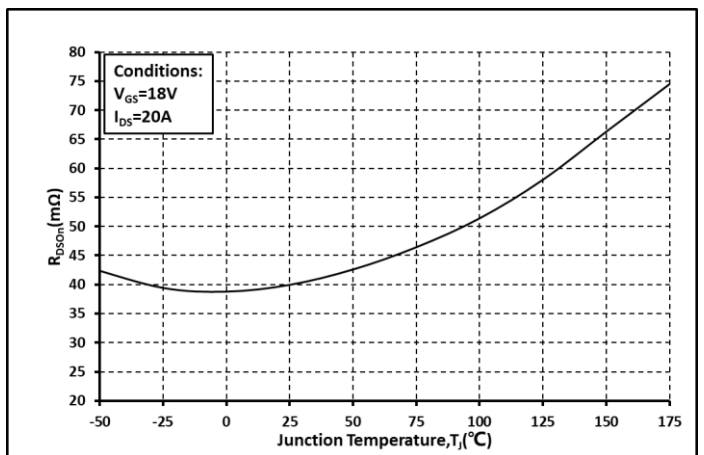


Fig. 4  $R_{on}$  vs. Temperature

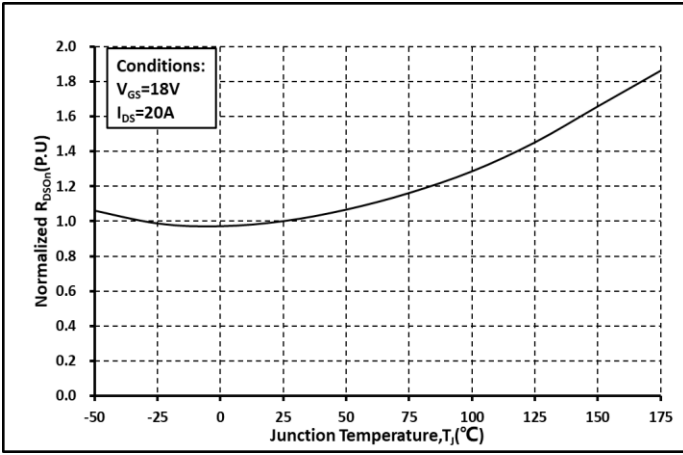


Fig. 5 Normalized Ron vs. Temperature

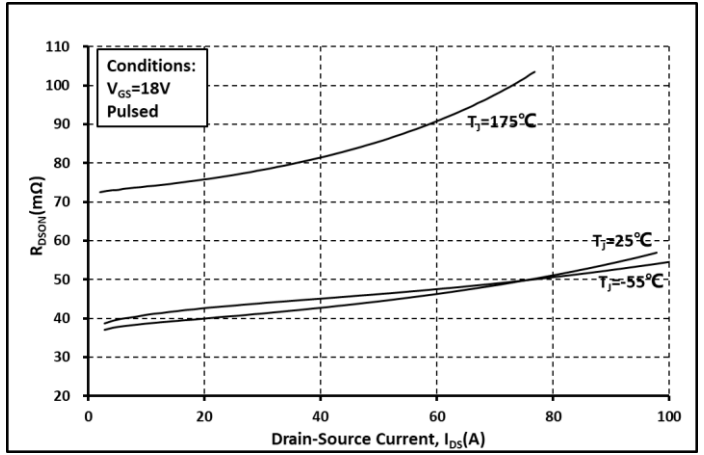


Fig. 6 Ron vs. Ids @ Various Temperature

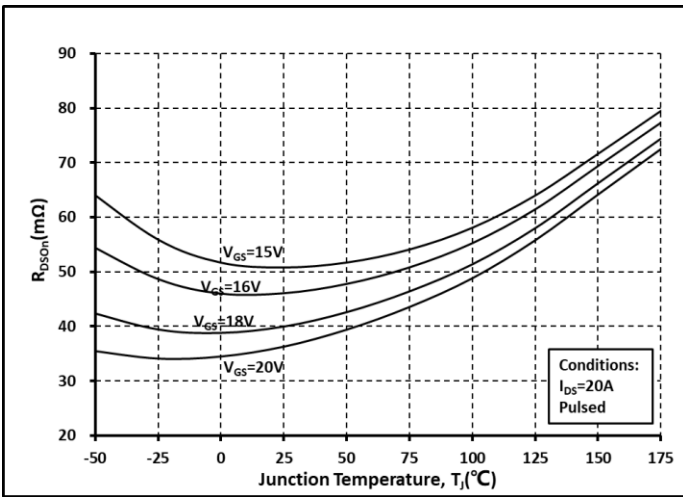


Fig. 7 Ron vs. Temperature @ Various Vgs

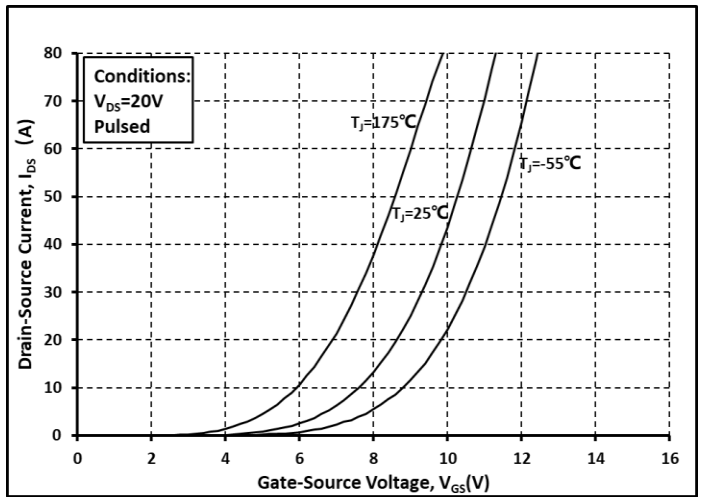


Fig. 8 Transfer Curves @ Various Temperature

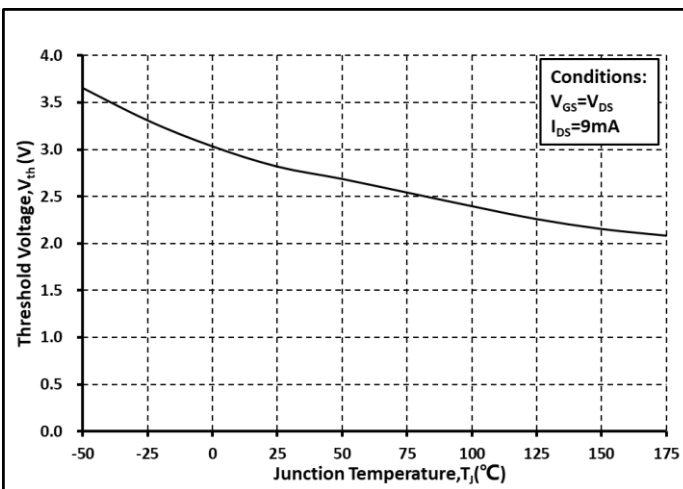


Fig. 9 Threshold Voltage vs. Temperature

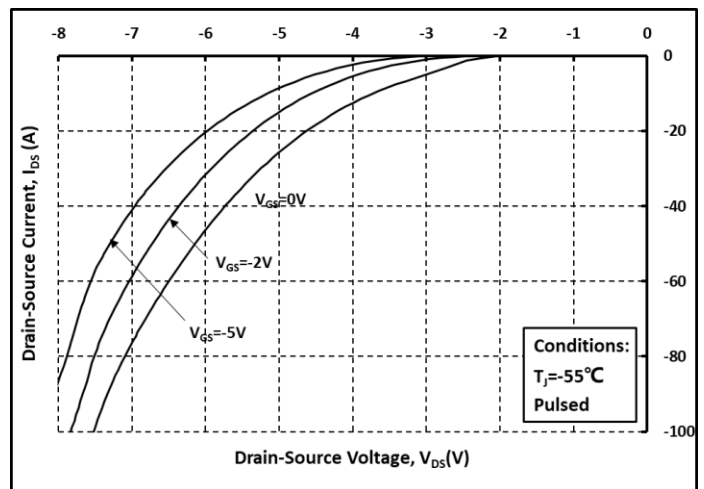


Fig. 10 Body Diode curves @ Tj = -55°C

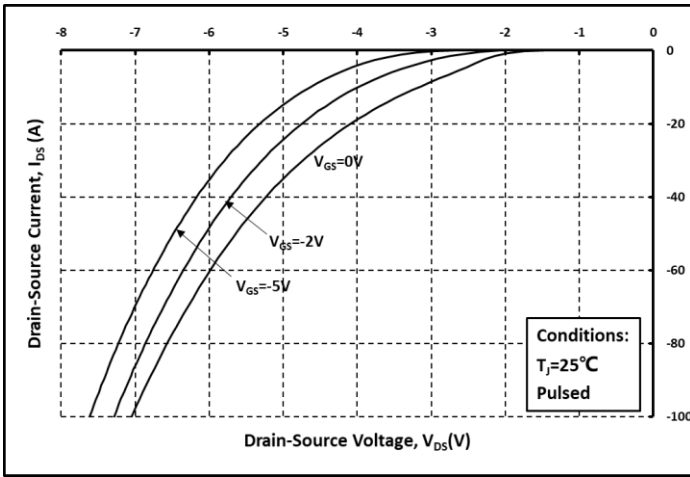


Fig. 11 Body Diode curves @  $T_j=25^\circ\text{C}$

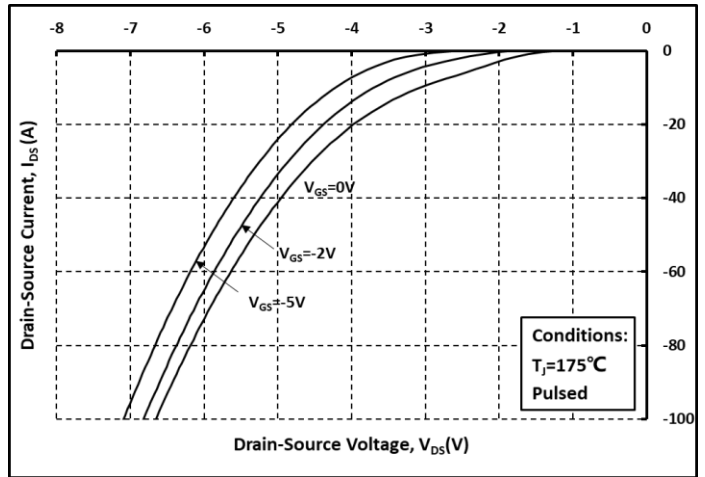


Fig. 12 Body Diode curves @  $T_j=175^\circ\text{C}$

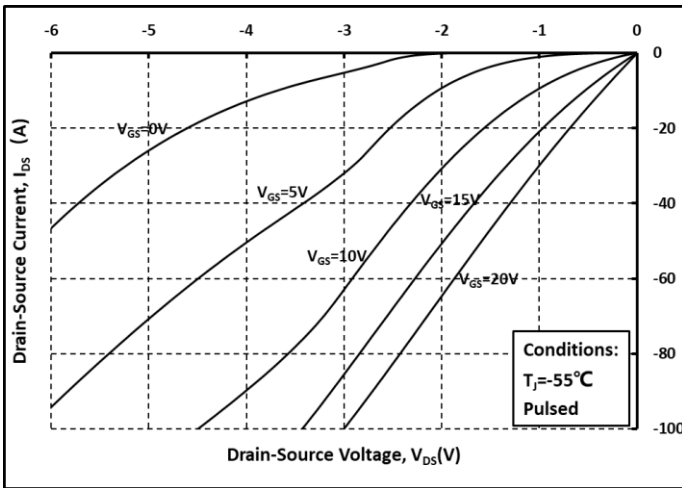


Fig. 13 3<sup>rd</sup> Quadrant curves @  $T_j=-55^\circ\text{C}$

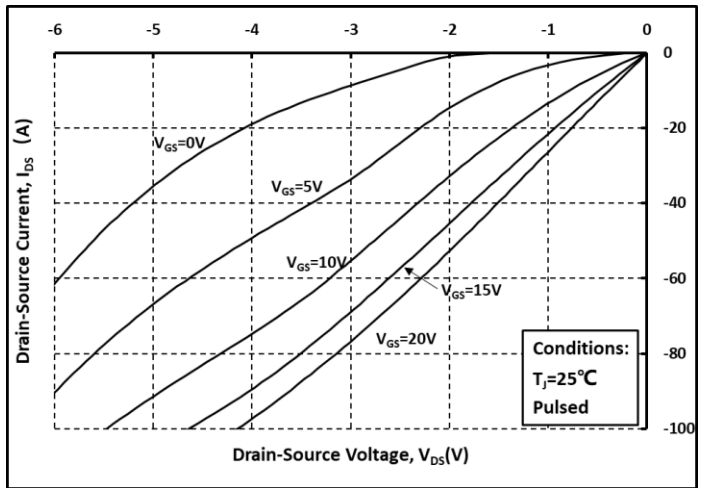


Fig. 14 3<sup>rd</sup> Quadrant curves @  $T_j=25^\circ\text{C}$

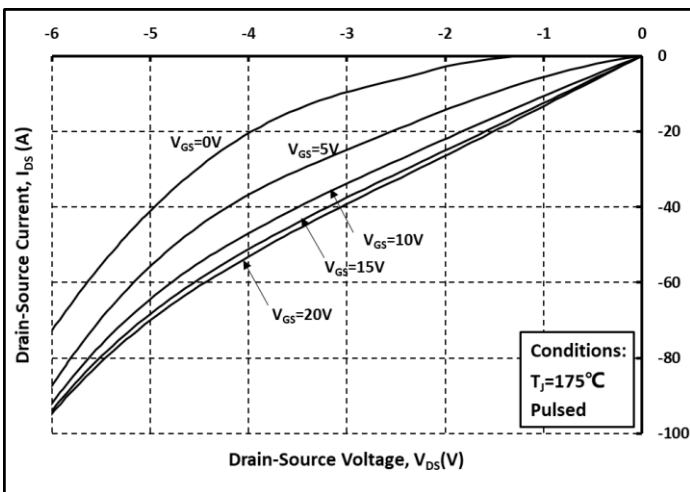


Fig. 15 3<sup>rd</sup> Quadrant curves @  $T_j=175^\circ\text{C}$

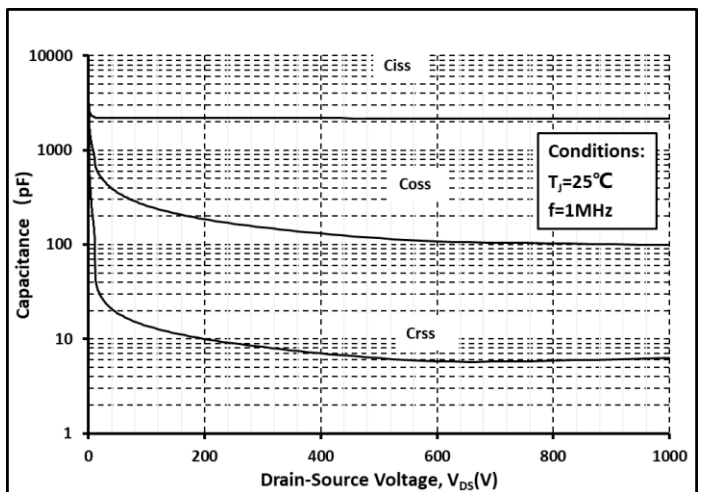


Fig. 16 Capacitance vs.  $V_{DS}$

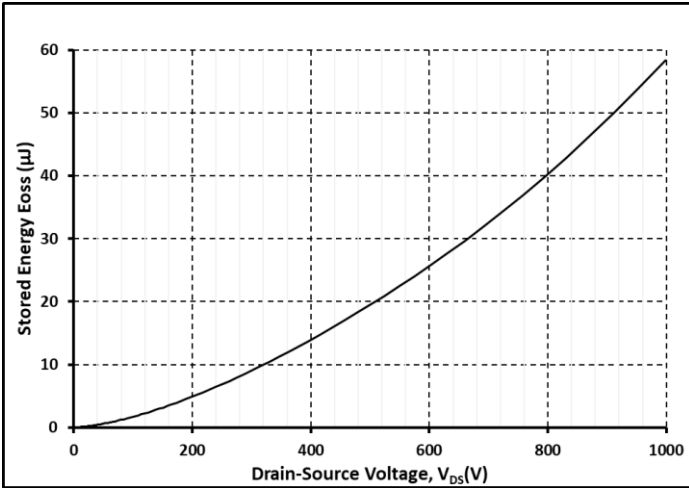


Fig. 17 Output Capacitor Stored Energy

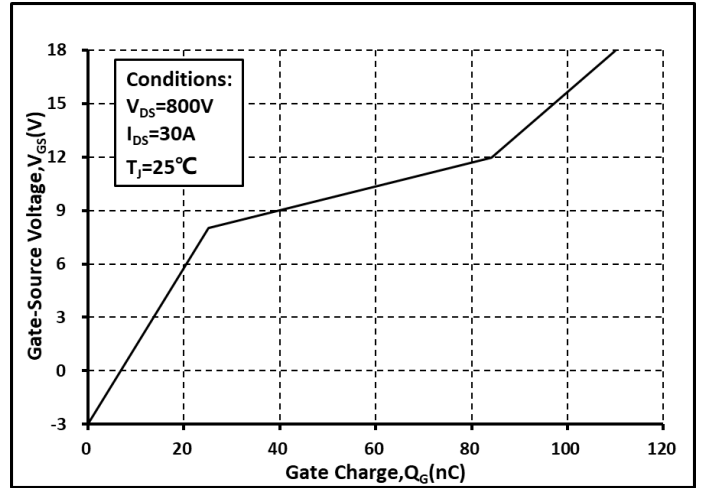


Fig. 18 Gate Charge Characteristics

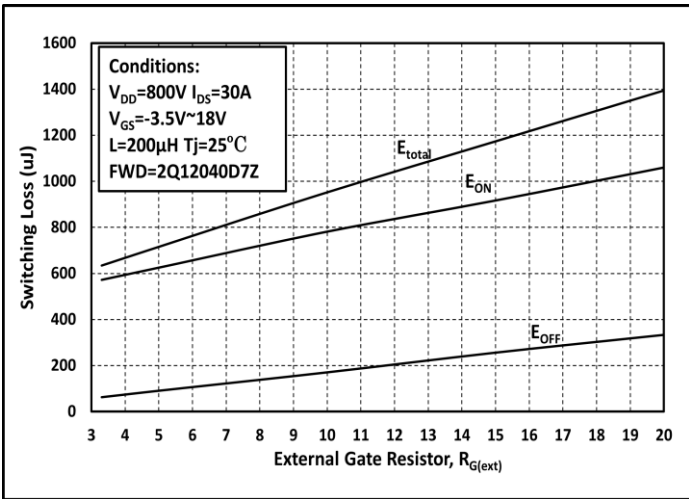


Fig. 19 Switching Energy vs. R<sub>G(ext)</sub>

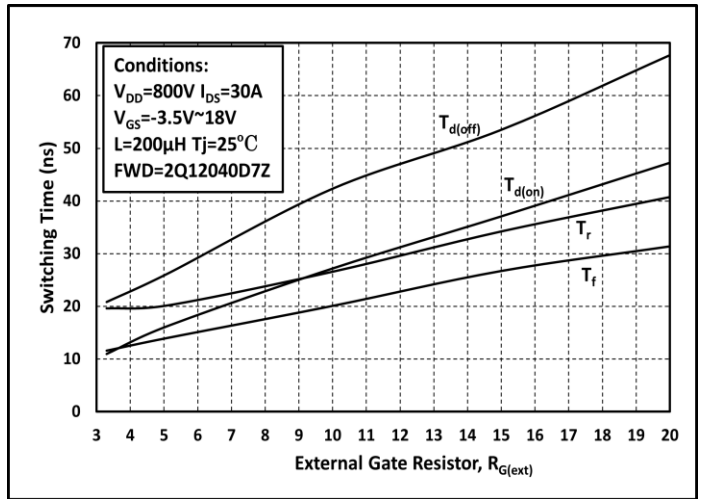


Fig. 20 Switching Times vs. R<sub>G(ext)</sub>

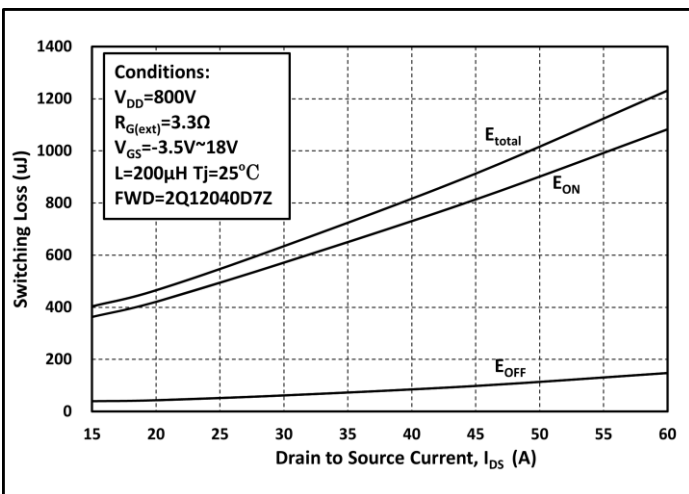


Fig. 21 Switching Energy vs. I<sub>DS</sub>

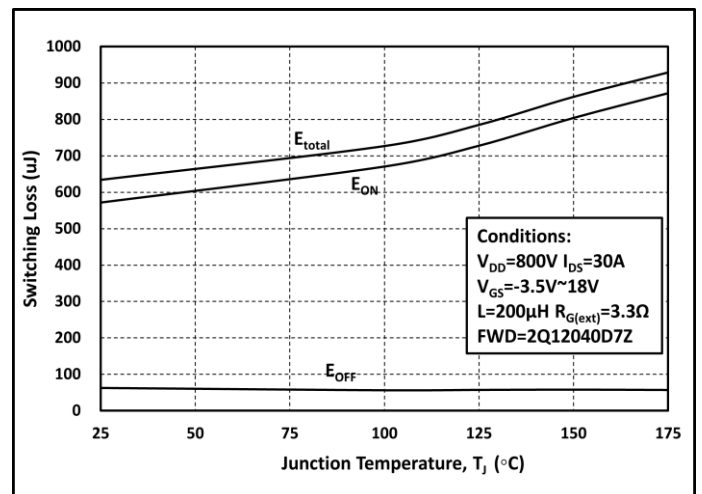


Fig. 22 Switching Energy vs. Temperature

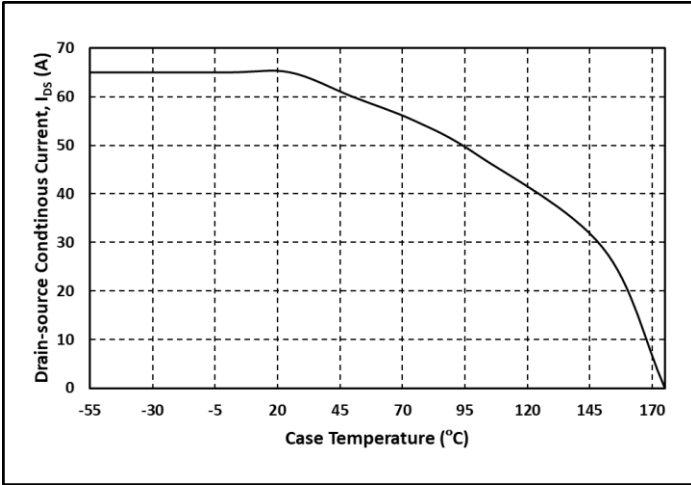


Fig. 23 Continuous Drain Current vs. Case Temperature

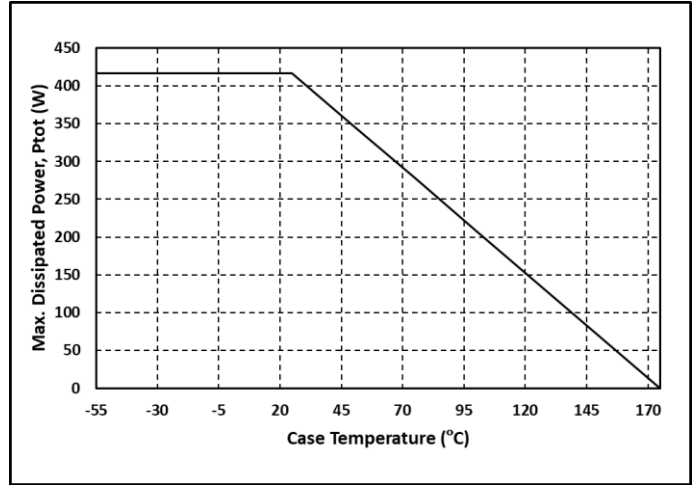


Fig. 24 Max. Power Dissipation Derating vs. Case Temperature

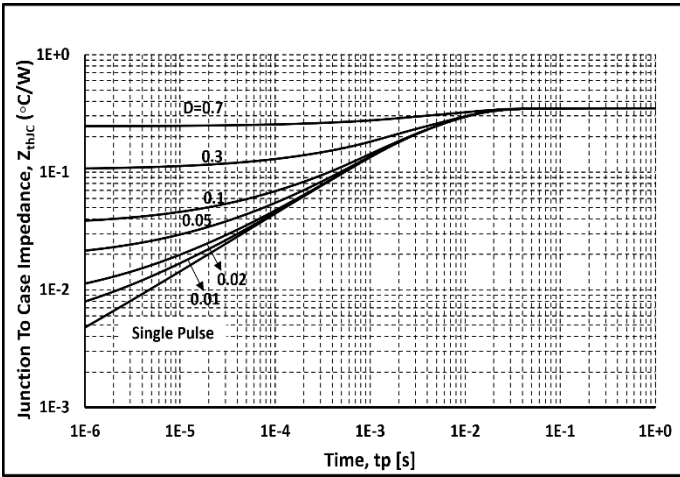


Fig. 25 Thermal impedance

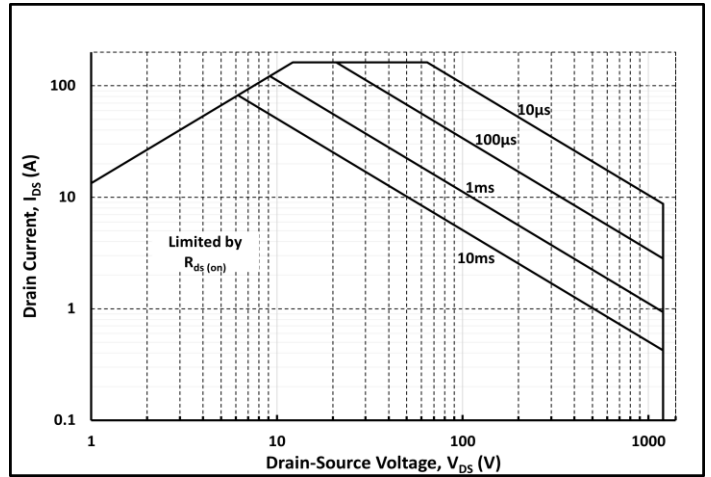
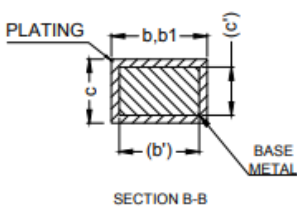
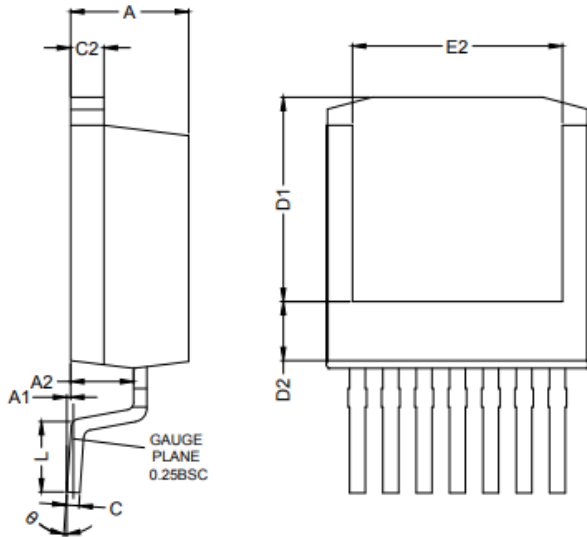
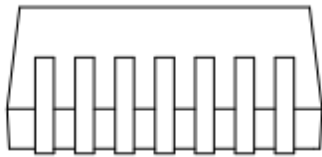
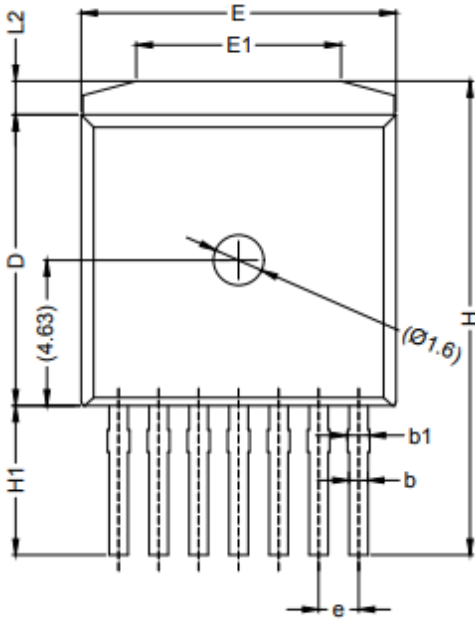


Fig. 26 Safe Operating Area

## Package Dimensions



Items	Min	Max
A	4.30	4.70
A1	-	0.25
A2	2.20	2.60
b	0.52	0.72
b'	0.50	0.70
b1	0.60	0.80
c	0.42	0.62
c'	0.40	0.60
c2	1.07	1.47
D	9.05	9.45
D1	7.58	7.98
D2	2.05	2.45
e	1.27 BSC	
E	9.80	10.20
E1	6.30	6.70
E2	7.80	8.20
L	2.48	2.88
L2	0.87	1.27
H	14.87	15.27
H1	4.55	4.95
θ	0°	8°

### Note:

1. Package Reference: JEDEC TO263, Variation AD
2. All Dimensions are in mm
3. Subject to Change Without Notice



## Notes

For further information please contact IVCT's office.

Copyright©2023 InventChip Technology Co., Ltd. All rights reserved.

The Information in this document is subject to change without notice.

## Related Links

<http://www.inventchip.com.cn>



## X-ON Electronics

Largest Supplier of Electrical and Electronic Components

*Click to view similar products for [MOSFET](#) category:*

*Click to view products by [InventChip](#) manufacturer:*

Other Similar products are found below :

[IRFD120](#) [IRFY240C](#) [JANTX2N5237](#) [2SK2267\(Q\)](#) [BUK455-60A/B](#) [MIC4420CM-TR](#) [VN1206L](#) [NDP4060](#) [SI4482DY](#)  
[IPS70R2K0CEAKMA1](#) [SQD23N06-31L-GE3](#) [TK16J60W,S1VQ\(O](#) [2SK2614\(TE16L1,Q\)](#) [DMN1017UCP3-7](#) [EFC2J004NUZTDG](#)  
[DMN1053UCP4-7](#) [SQJ469EP-T1-GE3](#) [NTE2384](#) [DMC2700UDMQ-7](#) [DMN2080UCB4-7](#) [DMN61D9UWQ-13](#) [US6M2GTR](#)  
[DMN31D5UDJ-7](#) [DMP22D4UFO-7B](#) [DMN1006UCA6-7](#) [DMN16M9UCA6-7](#) [STF5N65M6](#) [IRF40H233XTMA1](#) [STU5N65M6](#)  
[DMN6022SSD-13](#) [DMN13M9UCA6-7](#) [DMTH10H4M6SPS-13](#) [DMN2990UFB-7B](#) [IPB80P04P405ATMA2](#) [2N7002W-G](#) [MCAC30N06Y-](#)  
[TP](#) [MCQ7328-TP](#) [NTMC083NP10M5L](#) [NVMFS2D3P04M8LT1G](#) [BXP7N65D](#) [BXP4N65F](#) [AOL1454G](#) [WMJ80N60C4](#) [BXP2N20L](#)  
[BXP2N65D](#) [BXT1150N10J](#) [BXT1700P06M](#) [TSM60NB380CP](#) [ROG](#) [RQ7L055BGTCR](#) [DMNH15H110SK3-13](#)